Taiwan Semiconductor

# 8A, 200V - 600V Ultra Fast Rectifier

## FEATURES

- AEC-Q101 qualified available
- Glass passivated chip junction
- High efficiency, Low V<sub>F</sub>
- High current capability
- High reliability
- High surge current capability
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

## APPLICATIONS

- DC to DC converter
- Switching mode converters and inverters
- Freewheeling application

## **MECHANICAL DATA**

- Case: TO-220AC
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Mounting torque: 0.56 N·m maximum
- Meet JESD 201 class 2 whisker test
- Polarity: As marked
- Weight: 1.80g (approximately)

KEY PARAMETERS			
PARAMETER	VALUE	UNIT	
I <sub>F</sub>	8	А	
V <sub>RRM</sub>	200 - 600	V	
I <sub>FSM</sub>	100	А	
T <sub>J MAX</sub>	175	°C	
Package	TO-220AC		
Configuration	Single die		



R<sub>o</sub>HS

HALOGEN



1 3



ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25°C unless otherwise noted)					
PARAMETER	SYMBOL	MUR820	MUR840	MUR860	UNIT
Marking code on the device		MUR820	MUR840	MUR860	
Repetitive peak reverse voltage	V <sub>RRM</sub>	200	400	600	V
Reverse voltage, total rms value	V <sub>R(RMS)</sub>	140	280	420	V
Forward current	I <sub>F</sub>	8		Α	
Surge peak forward current 8.3ms single half sine wave superimposed on rated load	I <sub>FSM</sub>	100		А	
Junction temperature	Τ <sub>J</sub>	-55 to +175		°C	
Storage temperature	T <sub>STG</sub>	-55 to +175		°C	





THERMAL PERFORMANCE				
PARAMETER		SYMBOL	ТҮР	UNIT
Junction-to-case thermal resistance	MUR820	R <sub>ejc</sub>	3	°C/W
Junction-to-case thermal resistance	MUR840 MUR860	R <sub>eJC</sub>	2	°C/W

ELECTRICAL SPECIFIC	ATIONS	$T_A = 25^{\circ}C$ unless oth	nerwise noted)			
PARAMETER		CONDITIONS	SYMBOL	ТҮР	MAX	UNIT
Forward voltage <sup>(1)</sup>	MUR820		V <sub>F</sub>	-	0.975	V
	MUR840	$I_{F} = 8A, T_{J} = 25^{\circ}C$		-	1.300	V
	MUR860			-	1.700	V
Reverse current @ rated V <sub>R</sub> <sup>(2)</sup>		$T_J = 25^{\circ}C$	I <sub>R</sub>	-	5	μA
		$T_J = 100^{\circ}C$		-	250	μA
Reverse recovery time	MUR820	IF = 0.5A, IR = 1.0A	-	25	ns	
	MUR840 MUR860	Irr = 0.25A		-	50	ns

#### Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

## ORDERING INFORMATION

ORDERING CODE <sup>(1)(2)</sup>	PACKAGE	PACKING
MUR8x	TO-220AC	50 / Tube
MUR8xH	TO-220AC	50 / Tube

#### Notes:

- 1. "x" defines voltage from 200V(MUR820) to 600V(MUR860)
- 2. "H" means AEC-Q101 qualified



INSTANTANEOUS REVERSE CURRENT (uA)

## **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

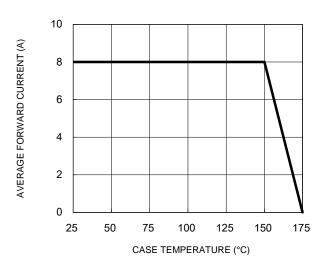
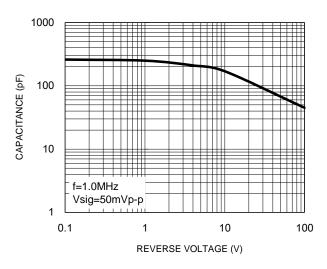


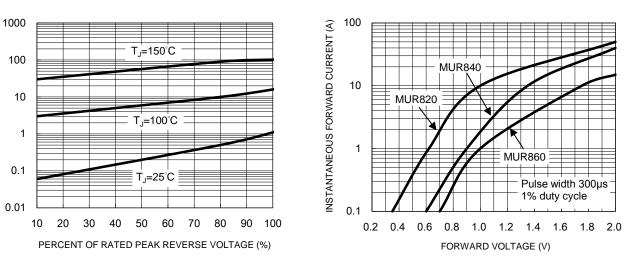
Fig.1 Forward Current Derating Curve

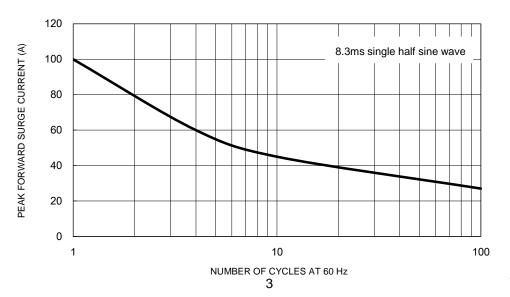
#### **Fig.3 Typical Reverse Characteristics**



#### **Fig.2 Typical Junction Capacitance**

**Fig.4 Typical Forward Characteristics** 





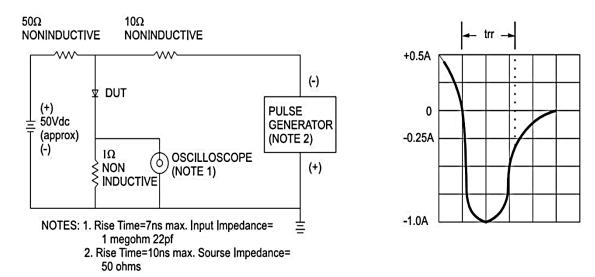
### Fig.5 Maximum Non-Repetitive Forward Surge Current

Version: K2103



## **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

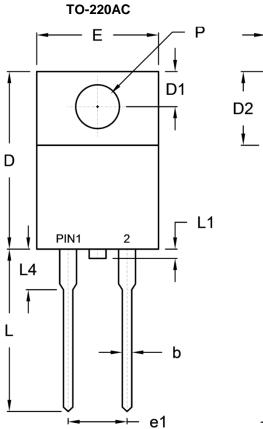


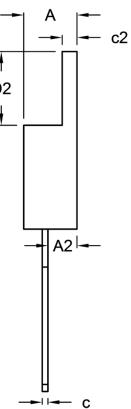
#### Fig.6 Reverse Recovery Time Characteristic and Test Circuit Diagram

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## **PACKAGE OUTLINE DIMENSIONS**





DIM.	Unit (mm)		Unit	(inch)
	Min.	Max.	Min.	Max.
А	4.42	4.76	0.174	0.187
A2	2.20	2.80	0.087	0.110
b	0.68	0.94	0.027	0.037
с	0.35	0.64	0.014	0.025
c2	1.14	1.40	0.045	0.055
D	14.60	16.00	0.575	0.630
D1	2.62	3.44	0.103	0.135
D2	5.84	6.86	0.230	0.270
E	-	10.50	-	0.413
e1	4.95	5.20	0.195	0.205
L	13.19	14.79	0.519	0.582
L1	0.00	1.60	0.000	0.063
L4	2.80	4.20	0.110	0.165
Р	3.54	4.00	0.139	0.157

### **MARKING DIAGRAM**



P/N	= Marking Code
G	= Green Compound
YWW	= Date Code
F	= Factory Code



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